

PATENT ASSIGNMENT COVER SHEET

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Stylesheet Version v1.2

EPAS ID: PAT3634069

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
NINGJIANG CHEN	11/13/2015
YUAN CHU	11/13/2015
CHONGLU WANG	11/13/2015
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State/Country:	CHINA
Postal Code:	201206
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14953318
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SIGNATURE:	/george l snyder jr/
DATE SIGNED:	11/28/2015
Total Attachments: 1	
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ASSIGNMENT OF INVENTION

WHEREAS, I, Ningjiang CHEN, Room 601, No. 33, Lane 316, West Gumei Road, Shanghai 201102, China; Yuan CHU, Building 22, 2250 Dongjin Road, Pudong District, Shanghai 201208, China; and Chonglu WANG, Room 602, No. 8, Lane 180, Tengchong Road, Minhang District, Shanghai, China, the undersigned, have invented certain new and useful improvements entitled **EMBEDDER**, for which an application for Letters Patent is being filed in the United States Patent and Trademark Office;

AND WHEREAS, Leica Microsystems Ltd. Shanghai, Bldg 1, 258 Jin Zang Rd., Jinqiao Export Processing Zone, Shanghai 201206, China, is desirous of acquiring all interest in said improvements, said application, and in any Letters Patent which may be granted therefor;

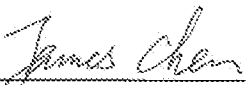
AND WHEREAS, at the time the improvements were made, I was under an obligation to assign all of my right, title, and interest in said improvements to Leica Microsystems Ltd. Shanghai.

NOW THIS INDENTURE WITNESSETH, that for the sum of one dollar and other valuable consideration to me in hand paid, the receipt of which is hereby acknowledged, I hereby assign, sell, and transfer unto said Leica Microsystems Ltd. Shanghai my entire right, title, and interest in said improvements, said application, and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements; and in and to any and all priority rights, rights under the International Convention For The Protection Of Industrial Property, rights under the Patent Cooperation Treaty, and other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto.

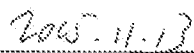
And I hereby authorize and request the Commissioner of Patents and Trademarks to issue said United States Letters Patent to said Leica Microsystems Ltd. Shanghai as the assignee of my whole right, title, and interest thereto.

And I further agree to sign and properly execute such necessary and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid improvements, as the assignee thereof shall hereafter require and prepare at its own expense.

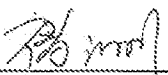
WITNESS, my signature and date of execution:



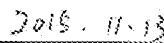
Ningjiang CHEN



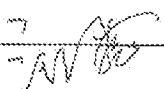
Date



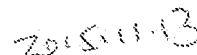
Yuan CHU



Date



Chonglu WANG



Date